AMIS-710404-A8: 400dpi CIS Module



1.0 General Description

The AMIS-710404-A8 (PI404MC-A8) is a contact image sensor (CIS) module. It is a long contact image chip, which uses MOS image sensor technology for high-speed performance and high sensitivity. The AMIS-710404-A8 is suitable for scanning A8 size (57mm) documents with 15.7 dots per millimeter (dpm) resolution. Applications include document scanning, mark readers, gaming and office automation equipment.

2.0 Key Features

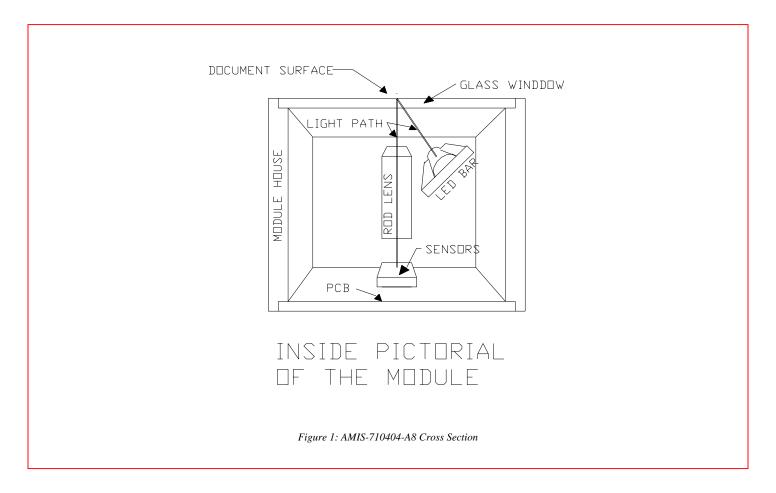
- · Light source, lens and sensor are integrated into a single module
- 15.7dpm resolution, 57mm scanning length
- 1.8msec/line scanning speed @ 500kHz clock rate
- Wide dynamic range
- · Analog output
- Yellow-Green light source 570nm
- Low power
- · Light weight

3.0 Functional Description

The AMIS-710404-A8 imaging array consists of 7 sensors, which are cascaded to provide 896 photo-detectors with their associated multiplex switches and a digital shift register, which controls its sequential readout. Mounted in the module is a one-to-one graded indexed micro lens array, which focuses the scanned documents to image onto its sensing plane. The on-board amplifier processes the video signal to produce a sequential stream of video at the video output pin of the AMIS-710404-A8 module.

Illumination is accomplished by means of an integrated LED light source. All components are housed in a small plastic housing which has a cover glass, which acts as the focal point for the object being scanned and protects the imaging array, micro lens assembly and LED light source from dust. I/O to the module is the 10-pin connector located on one end of the module (see Figure 4). The cross section of the AMIS-710404-A8 is shown in Figure 1 and the block diagram in Figure 2.





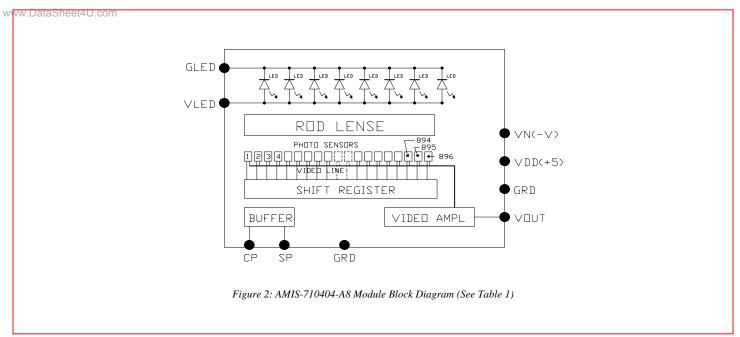


Table 1: Pin Configuration

Pin Number	Symbol	Names and Functions
1	Vout	Analog video output
2	Gnd	Ground; 0V
3	Vdd (+5V)	Positive power supply
4	Vn (-5V to -12V)	Negative power supply
5	Gnd	Ground; 0V
6	SP	Shift register start pulse
7	Gnd	Ground; 0V
8	СР	Sampling clock pulse
9	GLED	Ground for the light source; 0V
10	VLED	Supply for the light source

4.0 Absolute Maximum Rating

Table 2: Absolute Maximum Rating

Parameter	Symbols Maximum Rating		Units
Power supply voltage	Vdd	6	V
	ldd	40	ma
	Vn	-15	V
	In	10	ma
	VLED	5.5V	V
	ILED	300	ma
Input clock pulse (high level)	Vih	Vdd - 0.5V	V
Input clock pulse (low level)	Vil	-0.5	V

5.0 Environmental Specifications

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Table 3: Operating and Storage Environment

Symbols Maximum Rating		Units
Тор	0 to 50	°C
Нор	10 to 90	%
Tstg	-20 to +75	°C
Hstg	10 to 90	%
	Top Hop Tstg	Top 0 to 50 Hop 10 to 90 Tstg -20 to +75

(1) These are standard specifications for the CIS modules.



6.0 Electro-Optical Characteristics at 25°C

Table 4: Electro-Optical Characteristics at 25°C

Parameter	Symbol	Parameter	Units	Note
Number of photo detectors		896	Elements	
Pixel-to-pixel spacing		63.5	μm	
Line scanning rate	Tint ⁽¹⁾	2.92	msec	@ 307kHz clock frequency
Clock frequency ⁽²⁾	f	307	kHz	
Bright output voltage ⁽³⁾	Video output	2.0+/- 0.2	Volt	
Bright output non-uniformity ⁽⁴⁾	Up	+/-30	%	
Dark non-uniformity ⁽⁵⁾	Ud	<200	mV	
Dark output voltage ⁽⁶⁾	Dark level (DL)	-200 <dl<200< td=""><td>mV</td><td></td></dl<200<>	mV	
Modulation transfer function(')	MTF	>45	%	

Notes:

- (1) Tint: line scanning rate or integration time. Tint is determined by the interval between two start pulses (SP).
- (2) f: main clock frequency also equals the video sampling frequency.
- (3) Video output level is controlled with an adjustment as well as integration time.
- (4) Up = {[Vp(max) –Vp(min)]/Vp(max)}x100%
 Where VP(max) = maximum peak pixel and VP(min) = minimum pixel.
- (5) Ud = Vdmax Vdmin
 - Vdmin is the minimum output voltage with LED off.
 - Vdmax is maximum output voltage with LED off.
- 6) This level is measured from the reset level, which is located between the pixels, during the pixel reset duration. The reset level is at ground, 0V. It can be adjusted with the offset potentiometer located on the module.
- (7) MTF = [(Vp(n) Vp(n+1)] / (Vp(n)+ Vp(n+1)] x 100 [%] Vp(n): nth maximum output pixel from a 4.0 lp/mm target. V(n+1): (n+1)th minimum output pixel from a 4.0 lp/mm target.
- (8) Ip / mm: line pair per mm

7.0 Recommended Operating Conditions at 25°C

Table 5: Recommended Operating Conditions (25°C)

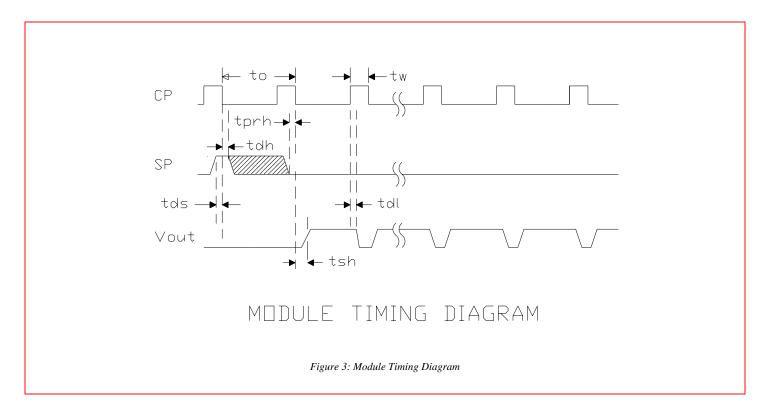
Item	Symbol	Min.	Тур.	Max.	Units
Power supply	Vdd	4.5	5.0	5.5	V
www.DataSheet4U.com	Vn.	-12	-5	-4.0	V
www.DataSrieet40.com	ldd		30		ma
	In		8		ma
	ILED		250	300	ma
	VLED		+5		V
Input voltage at digital high	Vih	Vdd -1.0	Vdd5	Vdd	V
Input voltage at digital low	Vil	0		0.6	V
Clock frequency	f	0.	0.30	1.0	MHz
Clock pulse high duty cycle			25		%
Clock pulse high duration			0.8		us
Integration time	Tint		3.0		ms
Operating temperature ⁽¹⁾	Тор		25	50	°C

Note:

(1) See the note under Table 3.



8.0 Switching Characteristics (25°C)



The switching characteristics (25°C) for the I/O clocks are shown in Figure 3. For the timing symbol definitions see Table 6.

Table 6: Timing Symbol's Definition and Timing Values

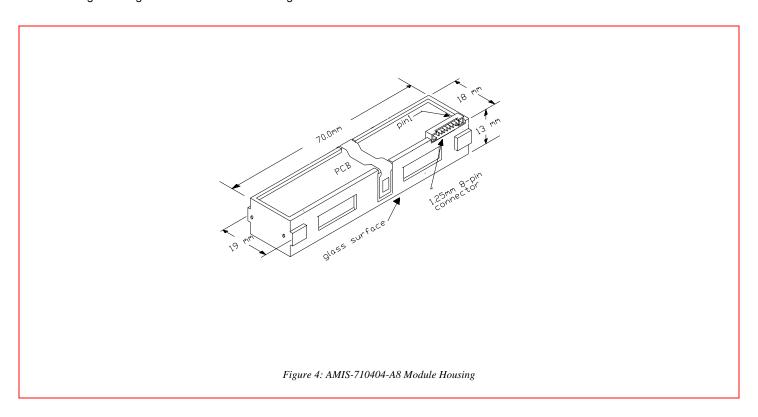
w item ataSheet4U.com	Symbol	Min.	Тур.	Max.	Units
Clock cycle time	to	1.0		4.0	μS
Clock pulse width	tw	250			ns
Clock duty cycle		25		75	%
Prohibit crossing time of SP ⁽¹⁾	tprh	0			ns
Data setup time	tds	20			ns
Data hold time	tdh	0			ns
Signal delay time	tdl	20			ns
Signal settling time	tsh	100			ns
Note:					

(1) "Prohibit crossing of start pulse" is to indicate that the start pulse should not be active high between any two consecutive high going clock pulses or two consecutive low going clock pulses (see Figure 3). Only one high going clock under the active high start pulse initiates the internal shift register, and it must not be active over two high going clocks. All low going clock pulses will not initiate the shift register but to ensure that the start pulse will not be actively high during two consecutive high going clocks, the circuit should be designed to keep the start pulse active only for one low going clock cycle.



9.0 Mechanical Structure of the Module

An isometric overview drawing of the AMIS-710404-A8 module's housing is shown in Figure 4. These modules are supplied with plastic end caps. However, for a more compact installation the end caps can be removed, provided that the modules are kept in the dark with no external light leakage allowed inside the housing.



Malthough the standard module comes with connector pins extruding to the sides as shown, a straight pinned socket can be installed into the PCB with its pins extruding directly up from its mount PCB. However, this must be requested upon ordering of the modules, otherwise the standard configuration will be shipped.

For module design-in, a detailed drawing is available upon request.

AMIS-710404-A8: 400dpi CIS Module



10.0 Company or Product Inquiries

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